

ST3DV520E

MUX/DEMUX for 4 differential channel LVDS and DDC

Features

■ Low R_{ON}: 4.0 Ω typical

V_{CC} operating range: 3.0 to 3.6 V

■ Enhanced ESD protection: > 8 kV (contact) and 15 kV (HBM)

■ Channel on capacitance: 9.5 pF typical

■ Switching time speed: 9 ns

Near to zero propagation delay: 250 ps
 Very low crosstalk: -45 dB at 250 MHz

■ Bit-to-bit skew: 200 ps

 > 600 MHz -3 dB typical bandwidth (or data frequency)

■ Support up to 4 differential LVDS channel

■ Support 2 channel for DDC

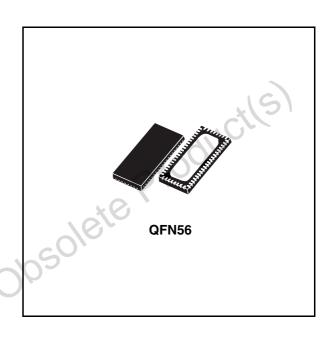
Independent SEL control for LVDS and DDC channels

■ Package: QFN56

Applications

■ Audio/video switching

■ High bandwidth physical layer signals routing



Description

The ST3DV520E is a 4 differential channel LVDS multiplexer/demultiplexer low R_{ON} bidirectional switch used to switch between multiple LVDS sources. It is designed for very low crosstalk, low bit-to-bit skew and low I/O capacitance, to maintain high signal integrity.

The differential signal from the LVDS transceiver is multiplexed into one of two selected outputs while the unselected switch goes to Hi-Z status.

The device integrates 2 SPDT (single pole dual throw) switches, for DDC channel.

SEL for LVDS and DDC channel is controlled independently.

Table 1. Device summary

Order code	Package	Packing
ST3DV520EQTR	QFN56	Tape and reel

Contents ST3DV520E

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ST3DV520E Pin description

1 Pin description



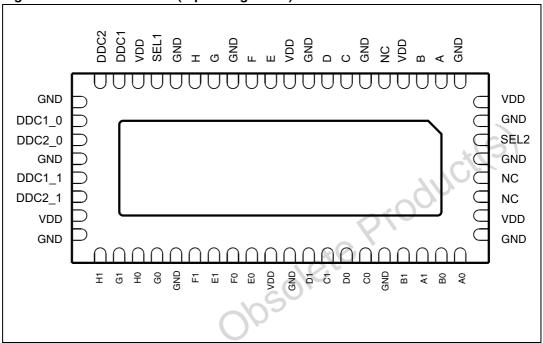


Table 2. Pin description

	Pin	Symbol	Name and function
	2, 3, 7, 8, 11, 12, 14, 15	A, B, C, D, E, F, G, H	8-bit bus
	48, 47, 43, 42, 37, 36, 32, 31	A0, B0, C0, D0, E0, F0, G0, H0	8-bit multiplexed to bus 0
	46, 45, 41, 40, 35, 34, 30, 29	A1, B1, C1, D1, E1, F1, G1, H1	8-bit multiplexed to bus 1
10	17	SEL1	LVDS channel selection
601	54	SEL2	DDC channel selection
003	19, 20	DDC1, DDC2	DDC switch input
0.	22, 23, 25, 26	DDC1_0, DDC2_0, DDC1_1, DDC2_1	DDC switch output
	4, 10, 18, 27, 38, 50, 56	V_{DD}	Supply voltage
	1, 6, 9, 13, 16, 21, 24, 28, 33, 39, 44, 49, 53, 55	GND	Ground
	5, 51, 52	NC	No internal connection

Pin description ST3DV520E

Figure 2. Input equivalent circuit

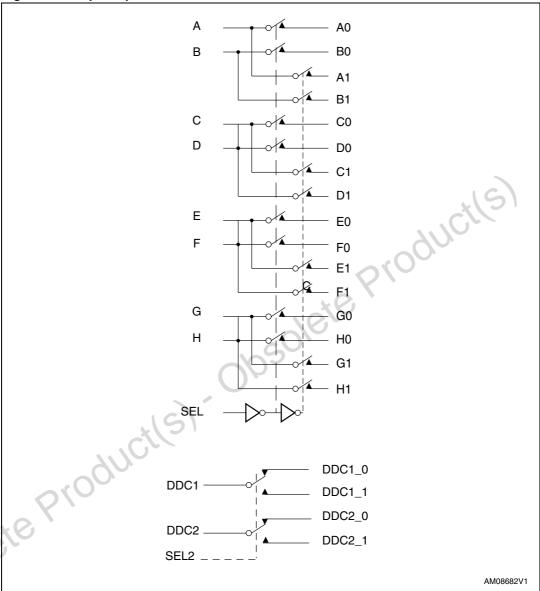


Table 3. LVDS switch function table

SEL1	Function
L	8-bit bus to 8-bit multiplexed bus 0
Н	8-bit bus to 8-bit multiplexed bus 1

Table 4. DDC switch function table

SEL2	Function
L	DDC switch input connected to DDC switch output X_0
Н	DDC switch input connected to DDC switch output X_1

ST3DV520E Maximum rating

2 Maximum rating

Stressing the device above the rating listed in the "absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 5. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage to ground	-0.5 to 4.6	V
V _{IO}	DC input output voltage	-0.5 to 4.6	V
V _{IC}	DC control input voltage	-0.5 to 4.6	V
Io	DC output current ⁽¹⁾	120	mA
P _D	Power dissipation	0.5	W
T _{stg}	Storage temperature	-65 to 150	°C
TL	Lead temperature (10 sec)	300	°C

^{1.} If $V_{IO} \times I_{O}$ does not exceed the maximum limit of P_{D} .

2.1 Recommended operating conditions

Table 6. Recommended operating conditions

	Symbol	Parameter		Value		Unit
	Symbol	raiailletei	Min	Тур	Max	Oill
	V _{CC}	Supply voltage to ground	3	-	3.6	V
10	V _{IC}	DC control input voltage (SEL1, 2)	0	-	V _{CC}	V
	V _{IO}	DC input/output voltage	0	-	V _{CC}	V
005	T _A	Operating temperature	-40	-	85	°C
OF						<u>.</u>

Electrical characteristics ST3DV520E

3 Electrical characteristics

Table 7. DC electrical characteristics

				-		
Symbol	Parameter	Test condition	,	-40 to 85 °C	; 	Unit
			Min	Тур	Max	
V _{IH}	Voltage input high (SEL1, 2)	High level guaranteed	2.4	-	-	V
V _{IL}	Voltage input low (SEL1, 2)	Low level guaranteed	-0.5	-	0.8	Sv
V _{IK}	Clamp diode voltage (SEL1, 2)	V _{CC} = 3.6 V I _{IN} = -18 mA	-	-0.8	-1.2	V
I _{IH}	Input high current (SEL1, 2)	$V_{CC} = 3.6 \text{ V}$ $V_{IN} = V_{CC}$		610	±5	μΑ
I _{IL}	Input low current (SEL1, 2)	$V_{CC} = 3.6 \text{ V}$ $V_{IN} = \text{GND}$	16/10	-	±5	μΑ
IOFF _(SW) ⁽¹⁾	Leakage current through the switch common terminals (A to H) (DDC1 to DDC2)	$V_{CC} = 3.6 \text{ V}$ A to H = V_{CC} DDC1 to DDC2 = V_{CC} A0 to H0 = 0 V A1 to H1 = floating DDCx_0 = 0 V DDCx1 = floating SEL1 = V_{CC} , SEL2 = V_{CC}	-	•	±1	μА
IOFF _(SEL1)	SEL1 pin leakage current	$V_{CC} = 0 \text{ V}$ SEL1, 2 = 0 to 3.6 V	-	-	±1	μΑ
R _{ON}	Switch ON resistance ⁽²⁾	$V_{CC} = 3.0 \text{ V}$ $V_{IN} = 1.5 \text{ to } V_{CC}$ $I_{IN} = -40 \text{ mA}$	-	4.0	6.5	Ω
R _{FLAT}	ON resistance flatness (2) (3)	$V_{CC} = 3.0 \text{ V}$ V_{IN} at 1.5 and VCC $I_{IN} = -40 \text{ mA}$	-	0.5	-	Ω
$\Delta R_{ ext{ON}}$	ON resistance match between channel $ \frac{\Delta R_{ON}}{(2)(4)} = R_{ONMAX} - R_{ONMIN} $	$V_{CC} = 3.0 \text{ V}$ $V_{IN} = 1.5 \text{ to } V_{CC}$ $I_{IN} = -40 \text{ mA}$	-	0.4	1	Ω

^{1.} Refer to Figure 4: Test circuit for leakage current (IOFF) on page 9

^{2.} Measured by voltage drop between channels at indicated current through the switch. ON resistance is determined by the lower of the voltages.

^{3.} Flatness is defined as the difference between the R_{ONMAX} and R_{ONMIN} of ON resistance over the specified range.

^{4.} ΔR_{ON} measured at same $V_{CC},$ temperature and voltage level.

Capacitance ($T_A = 25$ °C, f = 1 MHz) Table 8.

Symbol	Parameter	Test condition		Unit		
	Parameter		Min	Тур	Max	Offic
C _{IN}	SEL1, 2 pin input capacitance ⁽¹⁾	DC = 0.25 V AC = 0.5 V _{PP} f = 1 MHz	-	2	3	pF
C _{OFF}	Switch off capacitance ⁽²⁾	DC = 0.25 V AC = 0.5 V _{PP} f = 1 MHz	-	4	5	pF
C _{ON}	Switch on capacitance ⁽³⁾	DC = 0.25 V AC = 0.5 V _{PP} f = 1 MHz	-	9.5	11	pF

- 1. Refer to Figure 5 on page 10
- 2. Refer to Figure 6 on page 10
- 3. Refer to Figure 7 on page 11

Power supply characteristics Table 9.

	capacitance	f = 1 MHz				
1. Refer to	Figure 5 on page 10			9	0,	
2. Refer to	Refer to Figure 6 on page 10					
3. Refer to	. Refer to Figure 7 on page 11					
Table 9.	Power supply ch	naracteristics	10,			
		0/6		Value		
Symbol	Parameter	Test condition	-40 to 85 °C		Unit	
			Min	Тур	Max	
I _{CC}	Active mode power supply current	$V_{CC} = 3.6 \text{ V}, V_{IN} = V_{CC} \text{ or }$ GND	-	150	500	μΑ

Dynamic electrical characteristics ($V_{CC} = 3.3 \text{ V} \pm 10\%$) Table 10.

		100x	(00		Value		
	Symbol	Parameter	Test condition	-	40 to 85 °C	;	Unit
ansole				Min	Тур	Max	
	X _{talk}	Crosstalk ⁽¹⁾	R_L = 100 Ω f = 250 MHz	-	-45	-	dB
Ob	O _{IRR}	Off isolation ⁽²⁾	R_L = 100 Ω f = 250 MHz	-	-37	-	dB
	BW	-3 dB bandwidth ⁽³⁾	R_L = 100 Ω $0 < V_{IN} \le 3.6 V$	-	600	-	MHz

- 1. Refer to Figure 9 on page 12
- 2. Refer to Figure 10 on page 13
- 3. Refer to Figure 8 on page 11

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Table 11. Switching characteristics ($T_A = 25$ °C, $V_{CC} = 3.3$ V ±10%)

Cymbal	Dovemeter	Took oom dikion		I I m i t		
Symbol	Parameter	Test condition	Min	Тур	Max	Unit
t _{PD}	Propagation delay	V _{CC} = 3 to 3.6 V	-	0.25	-	ns
t _{PZH} ,	Line enable time, SEL to x to x0 or x to x1	V _{CC} = 3 to 3.6 V	0.5	6.5	15	ns
t _{PHZ} ,	Line disable time, SEL to x to x0 or x to x1	V _{CC} = 3 to 3.6 V	0.5	6.5	8.5	ns
t _{SK(O)}	Output skew between center port to any other port	V _{CC} = 3 to 3.6 V	-	0.1	0.2	ns
t _{SK(P)}	Skew between opposite transition of the same output (t _{PHL} , t _{PLH})	V _{CC} = 3 to 3.6 V	·P	0.1	0.2	ns

Table 12. ESD performance

Symbol	Test condition	Value			Unit
		Min	Тур	Max	Offic
ESD	Contact discharge ⁽¹⁾ IEC61000-4-2	-	±8	-	kV
	Human body model (MIL-STD-883)	-	±15	-	kV

^{1.} Refer to Figure 3: Diagram for suggested VDD decoupling on page 9.

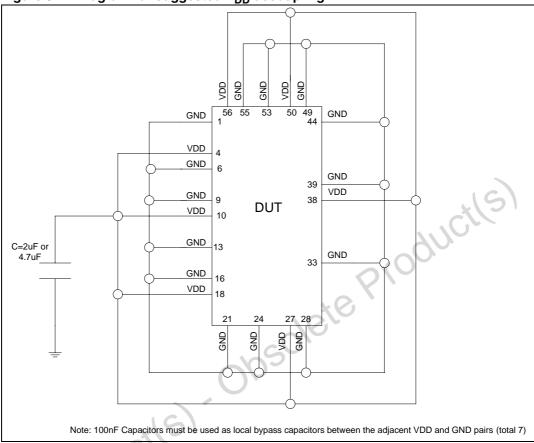
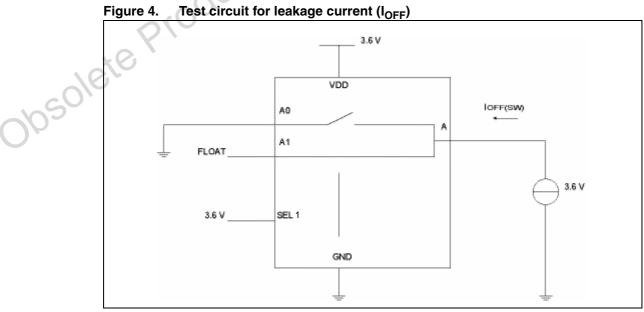


Figure 3. Diagram for suggested V_{DD} decoupling

1. Applicable for system level ESD test



Electrical characteristics ST3DV520E

Figure 5. Test circuit for SEL pin input capacitance (C_{IN})

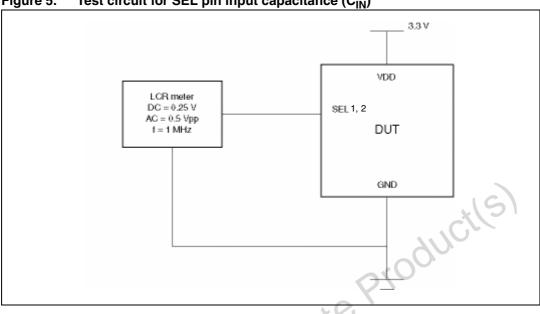
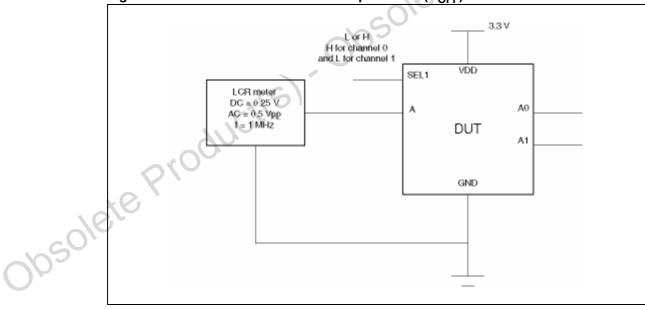


Figure 6. Test circuit for switch off capacitance (C_{OFF})



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LOR meter
DC = 0.25 V
AC = 0.5 Vpp
1 = 1 MHz

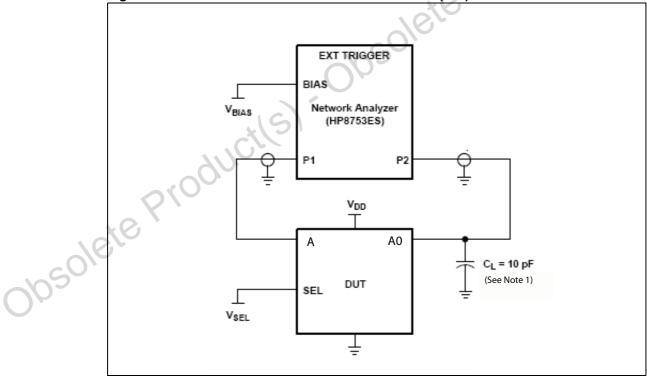
DUT

A1

GND

Figure 7. Test circuit for switch on capacitance (C_{ON})

Figure 8. Test circuit for bandwidth measurement (BW)



1. C_L includes proble and jig capacitance.

Frequency response is measured at the output of the ON channel. For example, when $V_{SEL1} = 0$ and A is the input, the output is measured at A0. All unused analog I/O ports are left open.

HP8753ES setup:

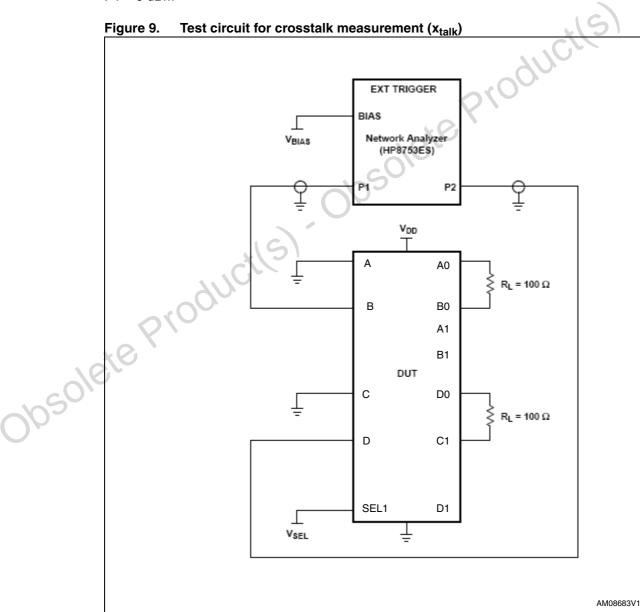
Average = 4

 $R_{BW} = 3 \text{ kHz}$

 $V_{BIAS} = 0.35 V$

ST = 2 s

P1 = 0 dBm



- 1. C_L includes proble and jig capacitance.
- 2. A 50 Ω termination resistor is needed to match the loading of the network analyzer.

Crosstalk is measured at the output of the non-adjacent ON channel. For example, when $V_{SEL1} = 0$, and B is the input, the output is measured at D. All unused analog input ports are connected to GND and output ports are left open.

HP8753ES setup:

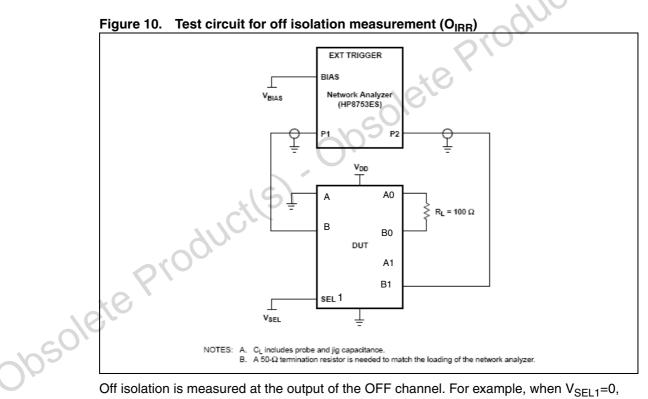
Average = 4

 $R_{BW} = 3 \text{ kHz}$

 $V_{BIAS} = 0.35 V$

ST = 2 s

P1 = 0 dBm



Off isolation is measured at the output of the OFF channel. For example, when $V_{SEL1}=0$, and B is the input, the output is measured at B1. All unused analog input ports are connected to GND and output ports are left open.

HP8753ES setup:

Average = 4

 $R_{BW} = 3 \text{ kHz}$

 $V_{BIAS} = 0.35 V$

ST = 2 s

P1 = 0 dBm

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Package mechanical data 4

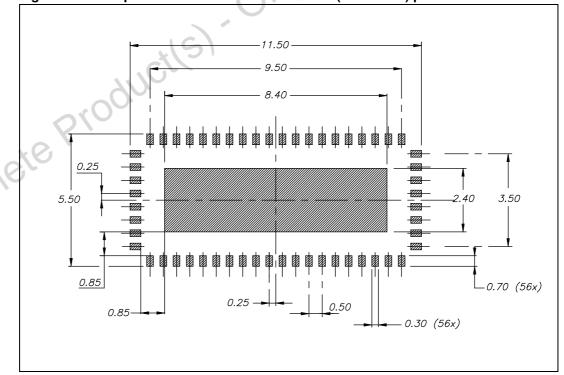
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Figure 11. Package outline for QFN56 (11 x 5 mm) pitch 0.5 mm PIN 1 I<u>DENTIFICATION</u> EXPOSED PAD 、ѱ╋┈╋┈╈┈╋┈╋ R (OPTIONAL) // 0.1 C -A3 SEATING PLANE Ċ Obsolete P' E/2 - D/2 -

Table 13. Mechanical data for QFN56 (11 x 5 mm) pitch 0.5 mm

Symbol	Millimeters			
Symbol	Min	Тур	Max	
А	0.70	0.75	0.80	
A1	-	-	0.05	
A3	_	0.20	-	
b	0.20	0.25	0.30	
D	10.90	11.00	11.10	
D2	8.30	8.40	8.50	
D3	-	9.50	· · · C ₇ /	
E	4.90	5.00	5.10	
E2	2.30	2.40	2.50	
E3	-	3.50	-	
е	_	0.50	-	
L	0.30	0.40	0.50	

Figure 12. Footprint recommendation for QFN56 (11 x 5 mm) pitch 0.5 mm



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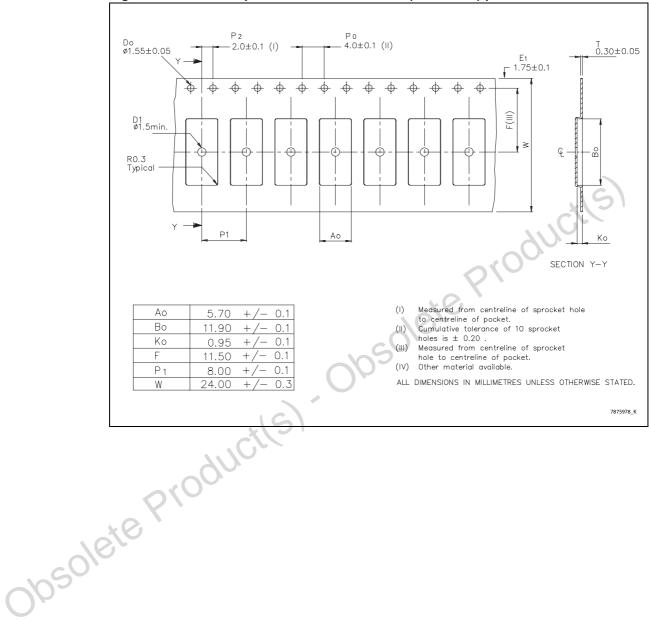


Figure 13. Carrier tape information for QFN56 (11 x 5 mm) pitch 0.5 mm

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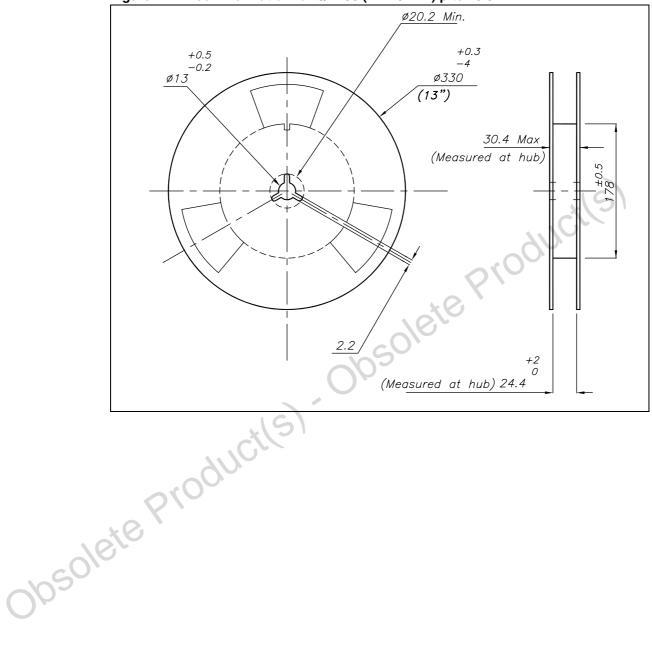


Figure 14. Reel information for QFN56 (11 x 5 mm) pitch 0.5 mm

Revision history ST3DV520E

5 Revision history

Table 14. Document revision history

Date	Revision	Changes
08-Dec-2010	1	Initial release.



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